

October 2004

ISL9V3036D3S / ISL9V3036S3S / ISL9V3036P3

EcoSPARKTM 300mJ, 360V, N-Channel Ignition IGBT

General Description

The ISL9V3036D3S, ISL9V3036S3S, and ISL9V3036P3 are the next generation IGBTs that offer outstanding SCIS capability in the space saving D-Pak (TO-252), as well as the industry standard D²-Pak (TO-263) and TO-220 plastic packages. These devices are intended for use in automotive ignition circuits, specifically as a coil drivers. Internal diodes provide voltage clamping without the need for external components.

EcoSPARK™ devices can be custom made to specific clamp voltages. Contact your nearest Fairchild sales office for more information.

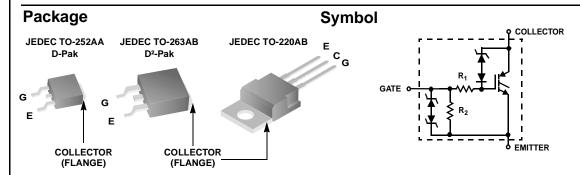
Formerly Developmental Type 49442

Applications

- · Automotive Ignition Coil Driver Circuits
- Coil- On Plug Applications

Features

- Industry Standard D²-Pak package
- SCIS Energy = 300mJ at T_J = 25°C
- Logic Level Gate Drive



Device Maximum Ratings T_J = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
BV _{CER}	Collector to Emitter Breakdown Voltage (I _C = 1 mA)	360	V
BV _{ECS}	Emitter to Collector Voltage - Reverse Battery Condition (I _C = 10 mA)	24	V
E _{SCIS25}	$T_J = 25$ °C, $I_{SCIS} = 14.2$ A, L = 3.0 mHy	300	mJ
E _{SCIS150}	$T_J = 150$ °C, $I_{SCIS} = 10.6A$, $L = 3.0$ mHy	170	mJ
I _{C25}	Collector Current Continuous, At T _C = 25°C, See Fig 9	21	Α
I _{C110}	Collector Current Continuous, At T _C = 110°C, See Fig 9	17	А
V_{GEM}	Gate to Emitter Voltage Continuous	±10	V
P _D	Power Dissipation Total T _C = 25°C	150	W
	Power Dissipation Derating T _C > 25°C	1.0	W/°C
T _J	Operating Junction Temperature Range	-40 to 175	°C
T _{STG}	Storage Junction Temperature Range	-40 to 175	°C
TL	Max Lead Temp for Soldering (Leads at 1.6mm from Case for 10s)	300	°C
T _{pkg}	Max Lead Temp for Soldering (Package Body for 10s)	260	°C
ESD	Electrostatic Discharge Voltage at 100pF, 1500Ω	4	kV

evice Marking Device Package		Reel Size	Reel Size		Width	,	Quantity			
V3036D ISL9V3036D3ST TO-252AA		330mm		16	3mm		2500			
V3036S ISL9V3036S3ST TO-263AB		330mm		24	lmm		800			
V3036F)	ISL9V3036P3	TO-220AA	Tube		N/A			50	
V3036E)	ISL9V3036D3S	TO-252AA	Tube	Tube		N/A		75	
V3036S	3	ISL9V3036S3S	TO-263AB	Tube		١	N/A		50	
	al C	haracteristic					Ι _		1	
Symbol		Paramet	er	Test Con	ditions	Min	Тур	Max	Units	
	,	acteristics		1			ı		1	
BV _{CER}	Colle	ector to Emitter Brea	I_C = 2mA, V_{GE} = 0, R_G = 1K Ω , See Fig. 15 T_J = -40 to 150°C		330	360	390	V		
BV _{CES}	Collector to Emitter Breakdown Voltage			$I_C = 10 \text{mA}, V_{GE} = 0,$ $R_G = 0, \text{ See Fig. 15}$ $T_J = -40 \text{ to } 150^{\circ}\text{C}$		350	380	410	V	
BV _{ECS}	Emitter to Collector Breakdown Voltage			$I_C = -75 \text{mA}, V_{GE} = 0 \text{V},$ $T_C = 25 ^{\circ}\text{C}$		30	-	-	V	
BV_{GES}		e to Emitter Breakdo		I _{GES} = ± 2mA		±12	±14	-	V	
I _{CER}	Colle	ector to Emitter Lea	kage Current	V _{CER} = 250V,	$T_C = 25^{\circ}C$	-	-	25	μΑ	
				$R_G = 1KΩ$, See Fig. 11	T _C = 150°C	-	-	1	mA	
I _{ECS}	Emit	tter to Collector Lea	kage Current	V _{EC} = 24V, See		-	-	1	mA	
				Fig. 11	$T_C = 150$ °C	-	-	40	mA	
R ₁	Series Gate Resistance					-	70	-	Ω	
R ₂		e to Emitter Resistar	100	1		10K	-	26K	Ω	
V _{CE(SAT)}	1	ector to Emitter Satu	ration Voltage	I _C = 6A,	T _C = 25°C,		1.25	1.60	ΙV	
				V _{GE} = 4V	See Fig. 3					
V _{CE(SAT)}		Collector to Emitter Saturation Voltage		$I_C = 10A,$ $V_{GE} = 4.5V$	T _C = 150°C, See Fig. 4	-	1.58	1.80	V	
V _{CE(SAT)}	V _{CE(SAT)} Collector to Emitter Saturation Voltage		$I_C = 15A,$ $V_{GE} = 4.5V$	T _C = 150°C	-	1.90	2.20	V		
ynamic	Char	acteristics								
$Q_{G(ON)}$	Gate Charge		I _C = 10A, V _{CE} = 12V, V _{GE} = 5V, See Fig. 14		-	17	-	nC		
$V_{GE(TH)}$	Gate	e to Emitter Thresho	old Voltage	$I_C = 1.0 \text{mA},$ $V_{CE} = V_{GE},$ See Fig. 10	$T_{C} = 25^{\circ}C$ $T_{C} = 150^{\circ}C$	1.3 0.75	-	1.8	V	
V _{GEP}	Gate	e to Emitter Plateau	Voltage	I _C = 10A,	V _{CE} = 12V	-	3.0	_	V	
		aracteristics		10 - 1	CE			<u>I</u>	<u>l</u>	
t _{d(ON)R}		rent Turn-On Delay	Time-Resistive	V _{CE} = 14V, R _L :	= 1Ω	-	0.7	4	μs	
t _{rR}	Current Rise Time-Resistive		$V_{GE} = 5V$, $R_G = 1K\Omega$ $T_J = 25^{\circ}C$, See Fig. 12		-	2.1	7	μs		
t _{d(OFF)L} Current Turn-Off Delay Time-Inductive		$V_{CE} = 300V, R_L = 500\mu H,$		-	4.8	15	μs			
t _{fL}	Curi	rent Fall Time-Induc	tive	$V_{GE} = 5V$, $R_G = 1K\Omega$ $T_J = 25$ °C, See Fig. 12		-	2.8	15	μs	
SCIS	Self Clamped Inductive Switching		$T_J = 25^{\circ}C, L = 3.0 \text{ mH},$ $R_G = 1K\Omega, V_{GE} = 5V$		_	1 _	300	mJ		

TO-252, TO-263, TO-220

 $\mathsf{R}_{\theta\mathsf{JC}}$

Thermal Resistance Junction-Case

1.0

°C/W

Typical Performance Curves

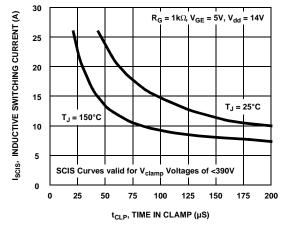


Figure 1. Self Clamped Inductive Switching Current vs Time in Clamp

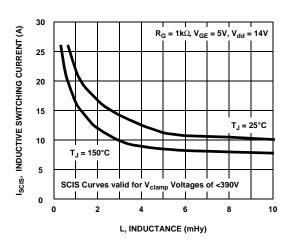


Figure 2. Self Clamped Inductive Switching Current vs Inductance

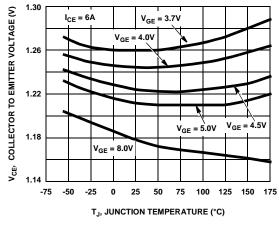


Figure 3. Collector to Emitter On-State Voltage vs Junction Temperature

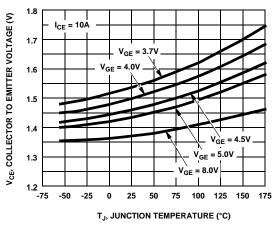


Figure 4. Collector to Emitter On-State Voltage vs Junction Temperature

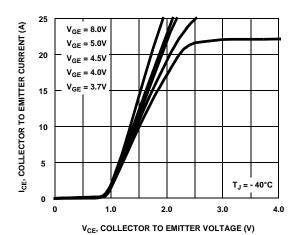


Figure 5. Collector to Emitter On-State Voltage vs Collector Current

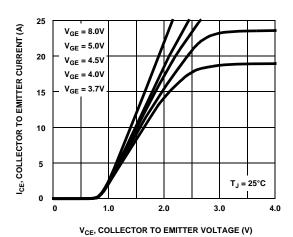
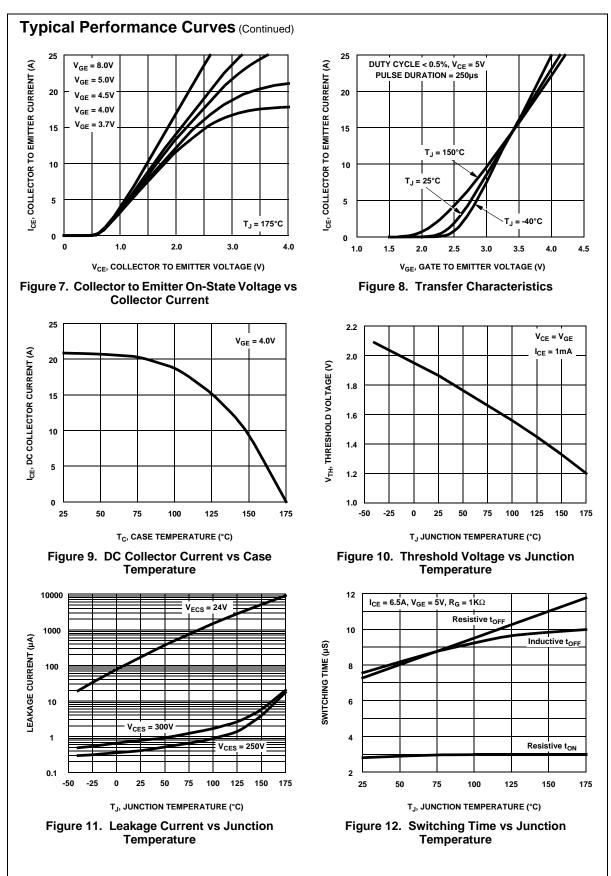


Figure 6. Collector to Emitter On-State Voltage vs Collector Current

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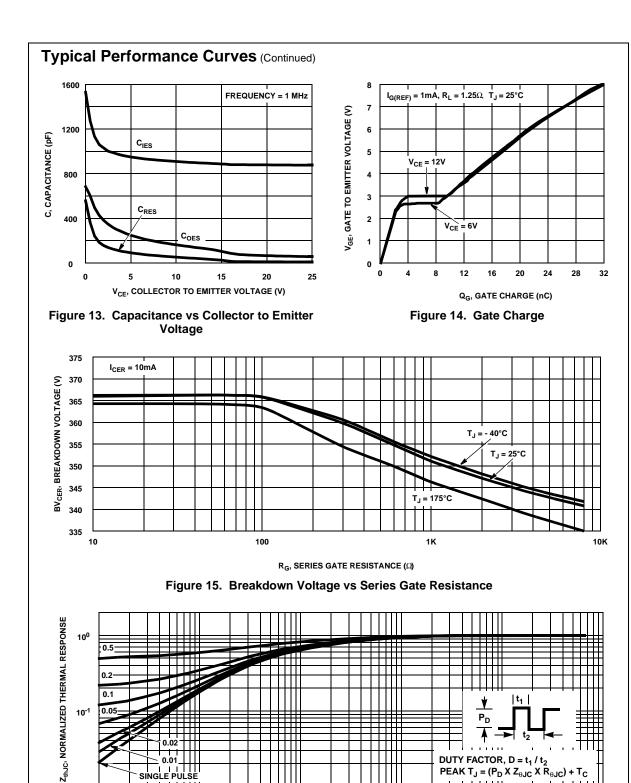


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case

T₁, RECTANGULAR PULSE DURATION (s)

10⁻³

10⁻⁴

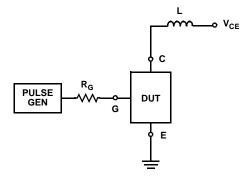
10⁻²

10⁻² 10⁻⁵

10⁻¹

10⁰

Test Circuit and Waveforms



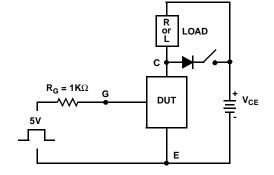
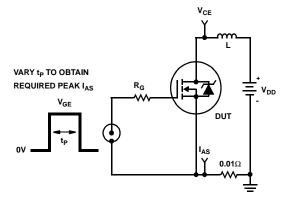


Figure 17. Inductive Switching Test Circuit

Figure 18. t_{ON} and t_{OFF} Switching Test Circuit

BV_{CES}



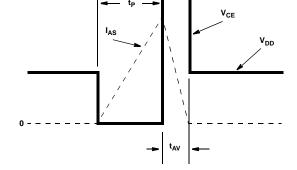
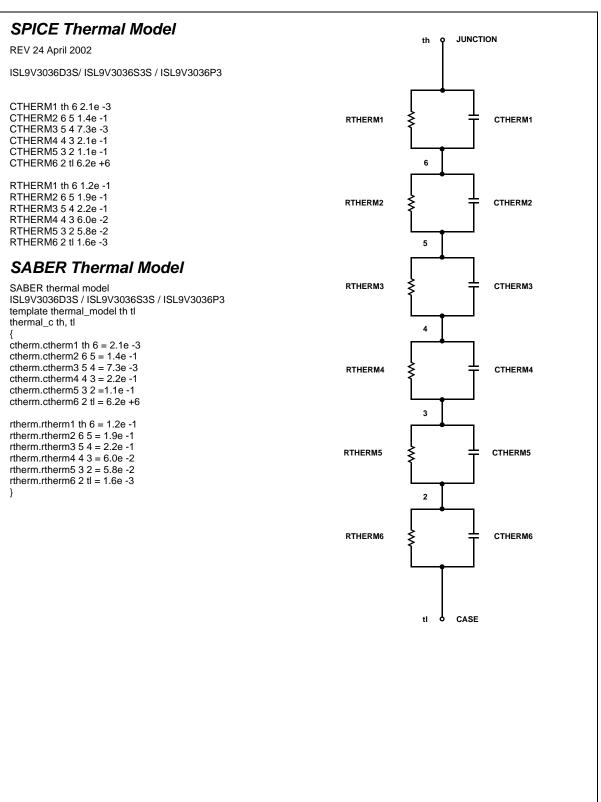


Figure 19. Unclamped Energy Test Circuit

Figure 20. Unclamped Energy Waveforms



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